

## SQ2310ES-T1-GE3-VB Datasheet N-Channel 20 V (D-S) MOSFET

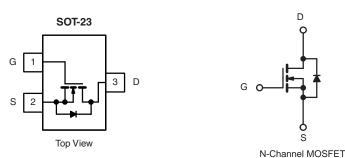
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>e</sup>	Q <sub>g</sub> (Typ.)			
	0.022 at V <sub>GS</sub> = 4.5 V	6 <sup>a</sup>				
20	0.028 at V <sub>GS</sub> = 2.5 V	6 <sup>a</sup>	8.8 nC			
	0.039 at V <sub>GS</sub> = 1.8 V	5.6				

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- DC/DC Converters
- Load Switch for Portable Applications



<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	20	V		
Gate-Source Voltage		V <sub>GS</sub>	± 12	V		
	T <sub>C</sub> = 25 °C		6 <sup>a</sup>			
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C		5.1			
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C		5 <sup>b, c</sup>			
	T <sub>A</sub> = 70 °C		4 <sup>b, c</sup>	A		
Pulsed Drain Current		I <sub>DM</sub>	20			
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		1.75			
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	1.04 <sup>b, c</sup>			
	T <sub>C</sub> = 25 °C	-	2.1			
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		1.3	w		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.25 <sup>b, c</sup>	VV		
	T <sub>A</sub> = 70 °C	1	0.8 <sup>b, c</sup>			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Tempera	-	260				

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	80	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	40	60	0/11		

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 °C/W.

e. Based on T\_C = 25 °C.



COMPLIANT HALOGEN FREE

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Uni
Static	<u> </u>					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	20			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		25		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = 250 μA		- 2.6		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.45		1.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA
		$V_{DS} = 20 V, V_{GS} = 0 V$			1	μA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5$ V, $V_{GS}$ = 4.5 V	20			A
		$V_{GS} = 4.5 \text{ V}, I_{D} = 5.0 \text{ A}$		0.022		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 4.7 \text{ A}$		0.028		Ω
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 4.3 A		0.039		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$		24		5
Dynamic <sup>b</sup>	010				I	
Input Capacitance	C <sub>iss</sub>			865		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		105		
Reverse Transfer Capacitance	C <sub>rss</sub>			55		
		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 5 V, I <sub>D</sub> = 5.0 A		12	18	
Total Gate Charge	Qg			8.8	14	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.0 \text{ A}$		1.1		
Gate-Drain Charge	Q <sub>gd</sub>			0.7		
Gate Resistance	R <sub>q</sub>	f = 1 MHz	0.5	2.4	4.8	2
Turn-On Delay Time	t <sub>d(on)</sub>		0.0	8	16	
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, \text{ R}_{1} = 2.2 \Omega$		17	26	_
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 4$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$		31	47	
Fall Time	t <sub>f</sub>	-		8	16	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	n
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2.2 $\Omega$		13	20	-
Turn-Off Delay Time		$I_D \cong 4 \text{ A}, \text{ V}_{\text{GEN}} = 5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		21	32	
Fall Time	t <sub>d(off)</sub> t <sub>f</sub>	- <b>3</b>		6	12	
Drain-Source Body Diode Characteristic				0	12	
Continuous Source-Drain Diode Current	,s I <sub>S</sub>	T <sub>C</sub> = 25 °C			1.75	
Pulse Diode Forward Current	I <sub>SM</sub>	10 - 20 0			20	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 4 A, V <sub>GS</sub> = 0 V		0.75	1.2	
Body Diode Reverse Recovery Time	v SD t <sub>rr</sub>	'S / ', 'GS - 0 '		12	20	
Body Diode Reverse Recovery Time Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			5	10	n n
Reverse Recovery Fall Time		$I_F = 4$ A, dI/dt = 100 A/µs, $T_J = 25$ °C		5 7	10	
neverse necovery rdli Tittle	t <sub>a</sub>		1	/	1	ns

emi

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Notes:

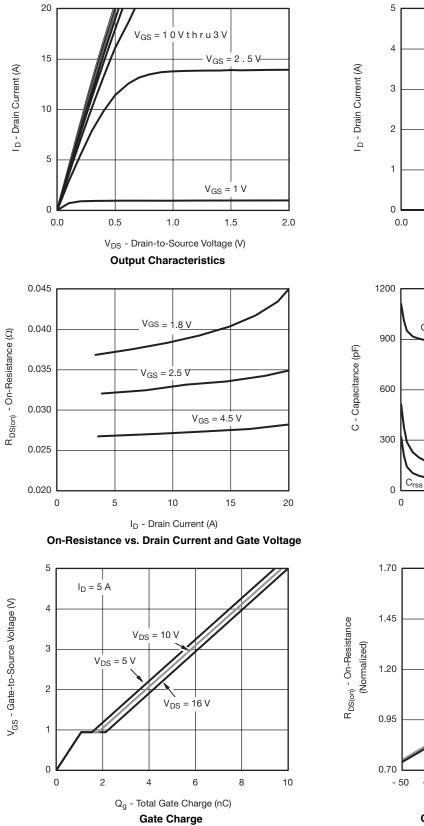
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

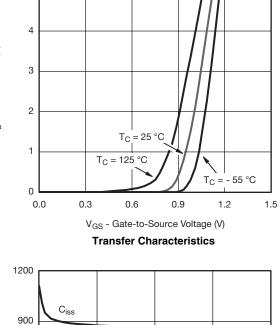
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

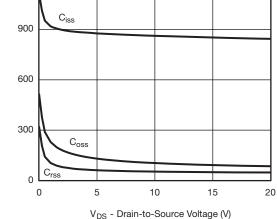
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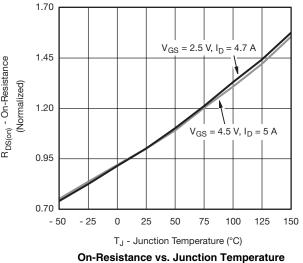
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Capacitance

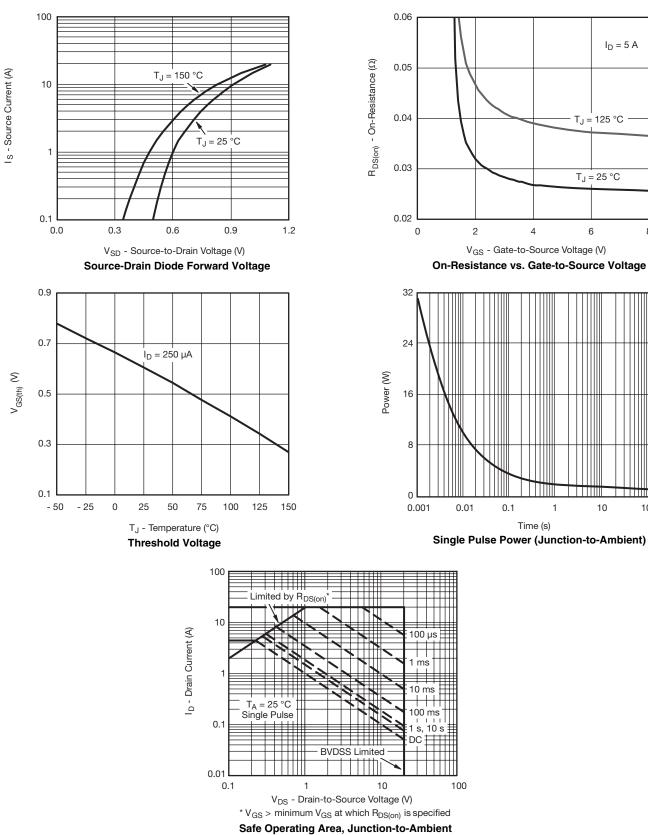


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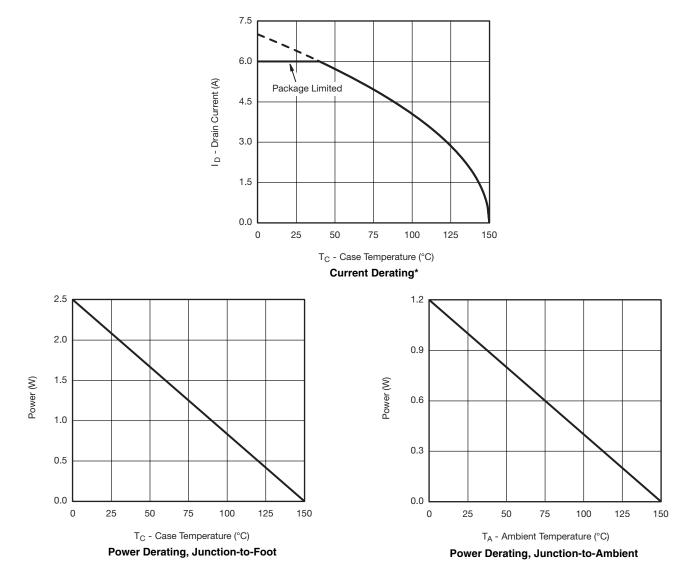
 $I_D = 5 A$ 







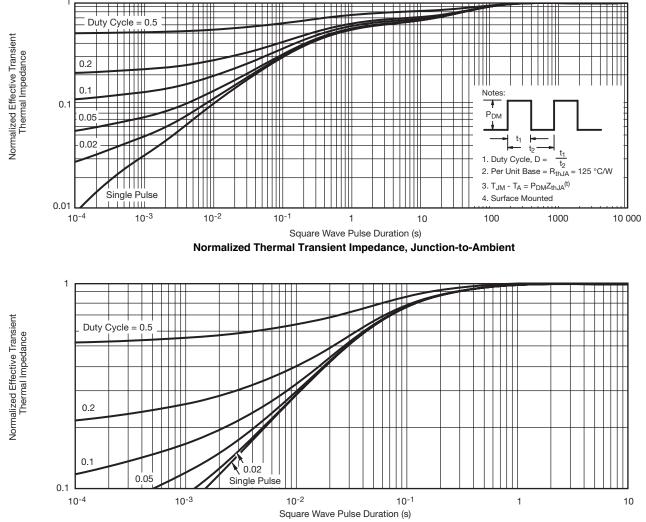
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



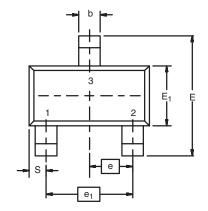
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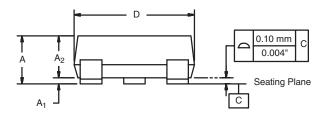


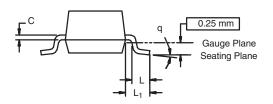
Normalized Thermal Transient Impedance, Junction-to-Foot



### SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	IETERS	INCHES		
	Min	Мах	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09-Jul-01 DWG: 5479					

## SQ2310ES-T1-GE3-VB



#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)



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